

## GaN 80-86 GHz PA

### Preliminary Datasheet

#### Product Features

- Frequency Range: 80-86 GHz
- Psat: 0.5 W
- Gain: 15 dB
- PAE: 15%
- Bias:  $V_d=12V$ ,  $I_d=210$  mA
- Chip dimensions: 3.4 x 1.35 x 0.05 mm

#### Primary Applications

- E-band high data rate wireless links
- Sensors and Radars

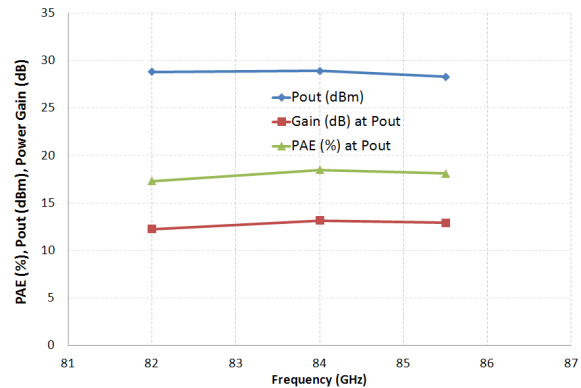
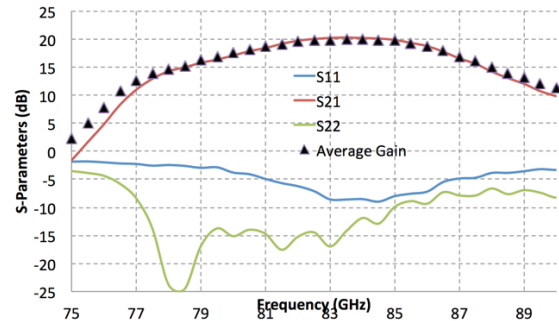
#### Product Description

The HRL G84-PA is a three stage power amplifier fabricated using HRL's T-gate GaN HEMT process (GaN-on-SiC). The amplifier has independent gate and drain bias for each stage. Front-side bond pads (RF and DC) and backside metallization are Ti/Au, which is compatible with conventional wire and ribbon bonding techniques, and die attach processes.

The G84-PA is estimated to provide 0.5 W output power with 17 dB small signal gain and a PAE of 15% at 84 GHz.

#### Typical Measured Performance

$V_d=12V$ ,  $I_{d1}=30mA$ ,  $I_{d2}=60mA$ ,  $I_{d3}=120mA$



#### Electrical Specifications

$V_d=12V$ ,  $I_{d1}=36mA$ ,  $I_{d2}=70mA$ ,  $I_{d3}=144mA$

Specification	Min	Typ	Max	Unit
Frequency	80		86	GHz
Linear Gain		15		dB
Input Return Loss		5		dB
Output Return Loss		8		dB
Estimated Psat		27		dBm

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## Absolute Maximum Ratings

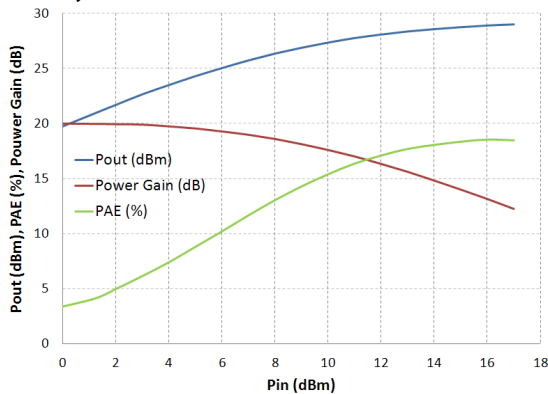
CW Operation

Parameter	Rating	Unit
Input Power (Pin)	20	dBm
Drain Voltage (Vd)	12	V
Gate Voltage Range (Vg)	-1 to -3.5	V
Drain Current (Id)	300	mA
Die Attach Temperature (30 sec)	290	°C

Exceeding any one or combination of the Absolute Maximum Ratings may result in permanent damage to the device. Application of Absolute Maximum Ratings on the device for an extended period of time may negatively affect the reliability of the device.

**Caution:** ESD sensitive device.

## Pout, PAE and Gain vs. Pin at 84 GHz



## Biasing Procedure

### Turn on

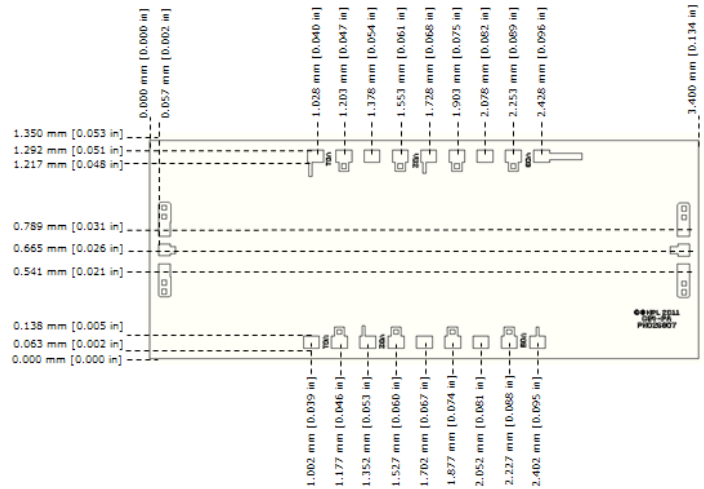
- 1)  $V_{g1} = V_{g2} = V_{g3} = -6$  V
- 2)  $V_{d1} = V_{d2} = V_{d3} = 12$  V
- 3) Adjust  $V_{g1}$  to obtain  $I_{d1} = 30$  mA
- 4) Adjust  $V_{g2}$  to obtain  $I_{d2} = 60$  mA
- 5) Adjust  $V_{g3}$  to obtain  $I_{d3} = 120$  mA

### Turn off

- 1)  $V_{d1} = V_{d2} = V_{d3} = 0$  V
- 2)  $V_{g1} = V_{g2} = V_{g3} = 0$  V

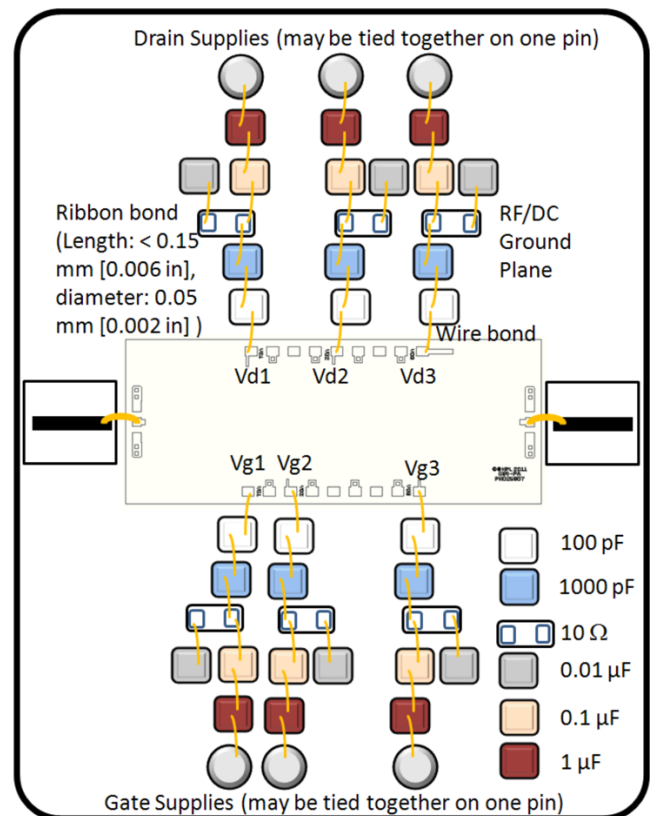
HRL recommends mounting the die on CuW heat spreader using AuSn eutectic solder.

## Outline Drawing



DC Bond Pads are 0.1mm<sup>2</sup>; Bond pad locations shown from die etch to pad center.

## Recommended Assembly Diagram



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